

FMI07N50E

FUJI POWER MOSFET

Super FAP-E³ series

N-CHANNEL SILICON POWER MOSFET

°C

■ Features

Maintains both low power loss and low noise Lower $R_{DS}(on)$ characteristic More controllable switching dv/dt by gate resistance Smaller V_{GS} ringing waveform during switching Narrow band of the gate threshold voltage (3.0±0.5V) High avalanche durability

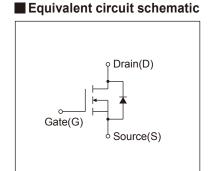
Applications

Switching regulators
UPS (Uninterruptible Power Supply)
DC-DC converters

■ Maximum Ratings and Characteristics

● Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

T-Pack(L) 1.219.2 1



Description Characteristics Symbol Unit Remarks V_{DS} **Drain-Source Voltage** VDSX 500 V V_{GS} = -30V **Continuous Drain Current** ΙD ±6.5 Α **Pulsed Drain Current** IDP ±26 Α Gate-Source Voltage Vgs ±30 Repetitive and Non-Repetitive Maximum Avalanche Current I_{AR} 6.5 Α Note*1 Non-Repetitive Maximum Avalanche Energy 266 Note*2 EAS mJ Repetitive Maximum Avalanche Energy E_{AR} 9.0 mJ Note*3 Peak Diode Recovery dV/dt dV/dt Note*4 54 kV/us Peak Diode Recovery -di/dt -di/dt 100 Note*5 A/µs 1.67 Ta=25°C **Maximum Power Dissipation** P_{D} W 90 Tc=25°C Tch 150 °C **Operating and Storage Temperature range**

Tsta

Electrical Characteristics at Tc=25°C (unless otherwise specified)

Description	Symbol	Conditions		min.	typ.	max.	Unit	
Drain-Source Breakdown Voltage	BVDSS	I _D =250µA, V _{GS} =0V		500	-	-	V	
Gate Threshold Voltage	V _{GS} (th)	In=250µA, Vns=Vs		2.5	3.0	3.5	V	
Zero Gate Voltage Drain Current	Ipss	V _{DS} =500V, V _{GS} =0V	T _{ch} =25°C	-	-	25		
	IDSS	V _{DS} =400V, V _{GS} =0V	Tch=125°C	-	-	250	μΑ	
Gate-Source Leakage Current	Igss	V _{GS} =±30V, V _{DS} =0V		-	10	100	nA	
Drain-Source On-State Resistance	R _{DS} (on)	I _D =3.3A, V _{GS} =10V		-	0.73	0.85	Ω	
Forward Transconductance	g fs	I _D =3.3A, V _{DS} =25V		3.5	7	-	S	
Input Capacitance	Ciss	V _{DS} =25V V _{GS} =0V f=1MHz		-	1050	1575	pF	
Output Capacitance	Coss			-	95	142.5		
Reverse Transfer Capacitance	Crss			-	7	10.5		
Turn-On Time	td(on)	V _{cc} =300V V _{ds} =10V I _D =3.3A R _G =10Ω		-	11	16.5	ns	
	tr			-	7	10.5		
Turn-Off Time	td(off)			-	75	113		
	tf			-	14	21		
Total Gate Charge	QG	V _{cc} =250V I _D =6.5A V _{GS} =10V		-	32	48	nC	
Gate-Source Charge	Qgs			-	8	12		
Gate-Drain Charge	Q _{GD}			-	9	13.5		
Avalanche Capability	lav	L=4.61mH, Tch=25°C		6.5	-	-	Α	
Diode Forward On-Voltage	V _{SD}	I _F =6.5A, V _{GS} =0V, T _{ch} =25°C		-	0.86	1.30	V	
Reverse Recovery Time	trr	I _F =6.5A, V _{GS} =0V		-	0.34	-	μs	
Reverse Recovery Charge	Qrr	-di/dt=100A/µs, Tch=25°C		-	3.0	-	μC	

Thermal Characteristics

Description	Symbol	Test Conditions	min.	typ.	max.	Unit
Thermal resistance	Rth (ch-c)	Channel to Case			1.390	°C/W
Thermal resistance	Rth (ch-a)	Channel to Ambient			75.0	°C/W

Note *1 : Tch≤150°C

Note *2 : Stating Tch=25°C, IAs=2.6A, L=72.1mH, Vcc=50V, Rc=50Ω

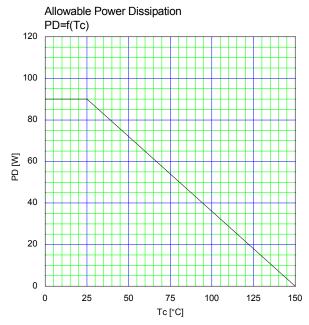
EAs limited by maximum channel temperature and avalanche current.

See to 'Avalanche Energy' graph.

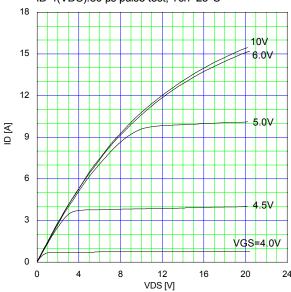
Note *3 : Repetitive rating : Pulse width limited by maximum channel temperature.

-55 to +150

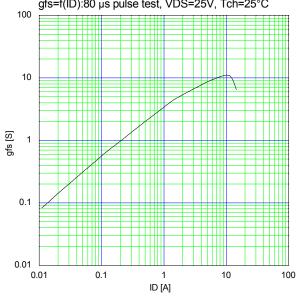
See to the 'Transient Themal impeadance' graph. Note *4 : IF<-ID, -di/dt=100A/ μ s, Vcc≤BVbss, Tch≤150°C. Note *5 : IF<-ID, dv/dt=5.4kV/ μ s, Vcc≤BVbss, Tch≤150°C.



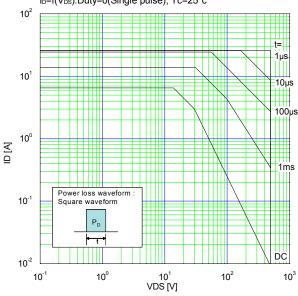
Typical Output Characteristics ID=f(VDS):80 µs pulse test, Tch=25°C



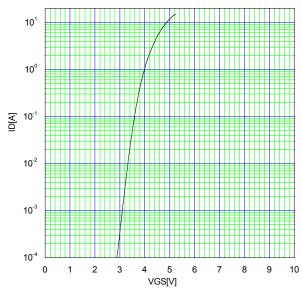
Typical Transconductance gfs=f(ID):80 µs pulse test, VDS=25V, Tch=25°C



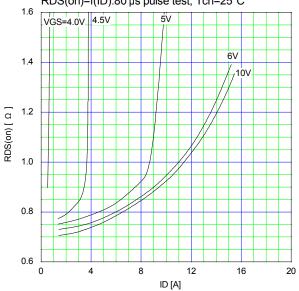
Safe Operating Area $I_D=f(V_{DS})$:Duty=0(Single pulse), Tc=25°c

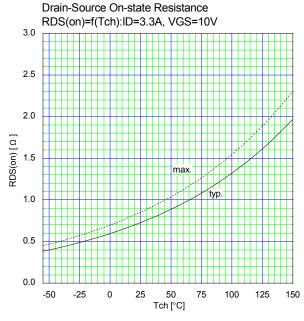


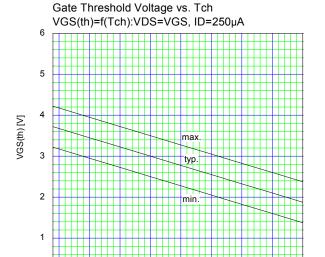
Typical Transfer Characteristic ID=f(VGS):80 μs pulse test, VDS=25V, Tch=25°C



Typical Drain-Source on-state Resistance RDS(on)=f(ID):80 µs pulse test, Tch=25°C

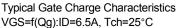


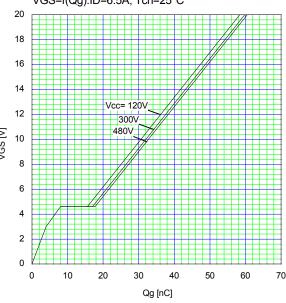




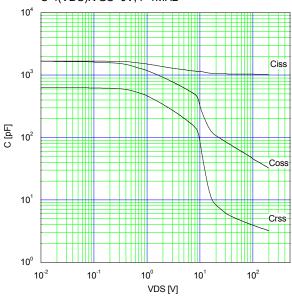
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Tch [°C]

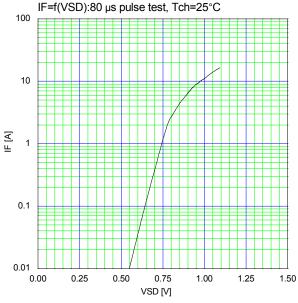




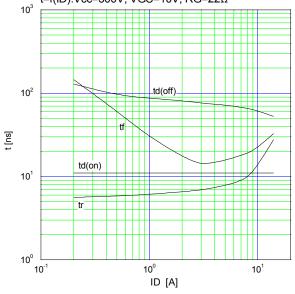
Typical Capacitance C=f(VDS):VGS=0V, f=1MHz



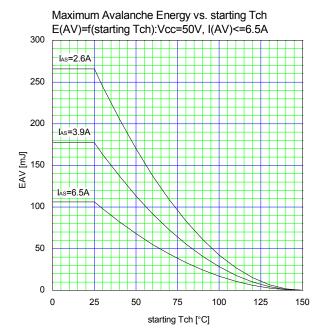
Typical Forward Characteristics of Reverse Diode IF=f(VSD):80 µs pulse test, Tch=25°C

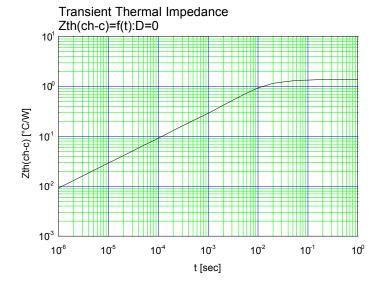


Typical Switching Characteristics vs. ID t=f(ID):Vcc=300V, VGS=10V, RG=22 Ω



http://www.fujielectric.com/products/semiconductor/





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